

#### TO-92S

#### Pin Definition:

1. V<sub>CC</sub> 2. GND





### Pin Definition:

- V<sub>CC</sub>
  Output
- 3. GND

## **Description**

TSH253 Hall-effect sensor is a temperature stable, stress-resistant switch. Superior high-temperature performance is made possible through a dynamic offset cancellation that utilizes chopper-stabilization. This method reduces the offset voltage normally caused by device over molding, temperature dependencies, and thermal stress. TSH253 includes the following on a single silicon chip: voltage regulator, Hall voltage generator, small-signal amplifier, chopper stabilization, Schmitt trigger, open-drain output. Advanced CMOS wafer fabrication processing is used to take advantage of low-voltage requirements, component matching, very low input-offset errors, and small component geometries.

### **Features**

- CMOS Hall IC Technology
- Solid-State Reliability much better than reed switch
- Omni polar output switches with absolute value of North or South pole from magnet
- Operation down to 1.8 V and Max at 6V.
- High Sensitivity for reed switch replacement
- ESD HBM ±4KV Min

#### **Application**

- Solid state switch, Revolution counter
- Lid close sensor for power supply devices
- Magnet proximity sensor for reed switch replacement in high duty cycle applications.
- Safety Key on sporting equipment
- Speed sensor, Position Sensor, Rotation Sensor

#### Absolute Maximum Rating (Ta = 25°C unless otherwise noted)

Characteristics	Limit	Value	Unit		
Supply voltage	V <sub>cc</sub>	6	V		
Output Voltage	V <sub>OUT</sub>	6	V		
Reverse voltage		V <sub>CC/OUT</sub>	-0.3	V	
Magnetic flux density			Unlimited	Gauss	
Output current	I <sub>OUT</sub>	1	mA		
Operating Temperature Range	T <sub>OPR</sub>	-40 to +85	°C		
Storage temperature range	T <sub>STG</sub>	-55 to +150	°C		
Maximum Junction Temp	TJ	150	°C		
Thermal Resistance - Junction to Ambient	TO-92S	0	206	°C/W	
mermai Resistance - Junction to Ambient	SOT-23	$\theta_{JA}$	543		
Thermal Desistance Innetion to Coop	TO-92S	0	148	°C/W	
Thermal Resistance - Junction to Case	SOT-23	$\theta_{JC}$	410		
Paakaga Bawar Dissingtion	TO-92S	D	606	m\//	
Package Power Dissipation	SOT-23	P <sub>D</sub>	230	mW	

**Note:** Exceeding the absolute maximum ratings may cause permanent damage. Exposure to absolute maximum-rated conditions for extended periods may affect device reliability.

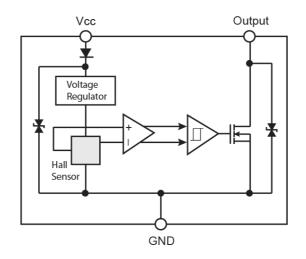
#### **Ordering Information**

Part No.	Package	Packing			
TSH253CT B0G	TO-92S	1Kpcs / Bulk Bag			
TSH253CX RFG	SOT-23	3Kpcs / 7" Reel			

#### Note: "G" denote for Halogen Free Product

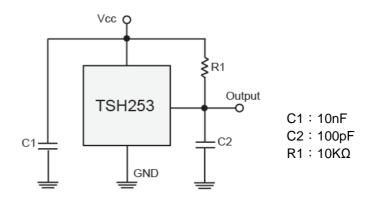


### **Block Diagram**



**Note:** Static sensitive device; please observe ESD precautions. Reverse VDD protection is not included. For reverse voltage protection, a  $100\Omega$  resistor in series with VDD is recommended.

## **Typical Application Circuit**



#### **Electrical Specifications** (DC Operating Parameters : T<sub>A</sub>=+25°C,V<sub>CC</sub>=5V)

Parameters	Test Conditions	Min	Тур	Max	Units
Supply Voltage	Operating	1.8		6	V
Supply Current	Average		2.6	6.0	mA
Output Low Voltage	I <sub>OUT</sub> =0.5mA			200	mV
Output Leakage Current	I <sub>OFF</sub> B <b<sub>RP, V<sub>OUT</sub> = 3V</b<sub>			10	uA
Output Rise Time	$R_L=10k\Omega$ , $C_L=20pF$			0.45	uS
Output Fall Time	$R_L=10k\Omega; C_L=20pF$			0.45	uS
Electro-Static Discharge	НВМ	4			KV



### Magnetic Specifications (TSH253CT)

Parameter	Symbol	Test Conditions	Min.	Тур.	Max.	Units
Operating	B <sub>OPS</sub>	S pole to branded side, $B > B_{OP}$ , Vout On		30	60	Gauss
Point	B <sub>OPN</sub>	N pole to branded side, $B > B_{OP}$ , Vout On	-60	-30		Gauss
Release	B <sub>RPS</sub>	S pole to branded side, $B < B_{RP}$ , Vout Off	5	25		Gauss
Point	B <sub>RPN</sub>	N pole to branded side, $B < B_{RP}$ , Vout Off		-25	-5	Gauss
Hysteresis	B <sub>HYS</sub>	BOPx - BRPx		5		Gauss

Note: 1G (Gauss) = 0.1mT (millitesta)

### Magnetic Specifications (TSH253CX)

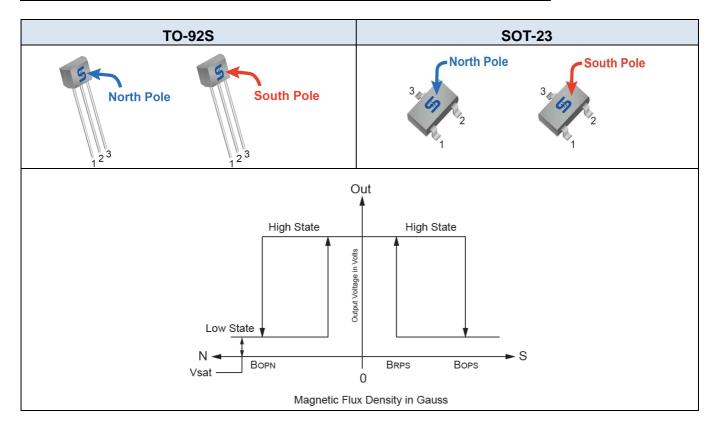
Parameter	Symbol	Test Conditions	Min.	Тур.	Max.	Units
Operating B <sub>OPS</sub>		N pole to branded side, $B > B_{OP}$ , Vout On		30	60	Gauss
Point	B <sub>OPN</sub>	S pole to branded side, $B > B_{OP}$ , Vout On	-60	-30		Gauss
Release	B <sub>RPS</sub>	N pole to branded side, $B < B_{RP}$ , Vout Off	5	25		Gauss
Point	B <sub>RPN</sub>	S pole to branded side, $B < B_{RP}$ , Vout Off		-25	-5	Gauss
Hysteresis	B <sub>HYS</sub>	BOPx - BRPx		5		Gauss

Note: 1G (Gauss) = 0.1mT (millitesta)

### **Output Behavior versus Magnetic Pole**

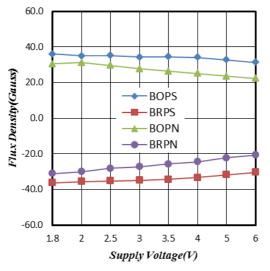
DC Operating Parameters:  $T_A = -40$  to  $125^{\circ}$ C,  $V_{CC} = 1.8$ V ~ 6V

Parameter	Test condition	OUT			
South pole	B <bop[(-60)~(-5)]< th=""><th>Low</th></bop[(-60)~(-5)]<>	Low			
Null or weak magnetic field	B=0 or B < BRP	Open(Pull-up Voltage)			
North pole	B>Bop(60~5)	Low			





### **Characteristic Performance**





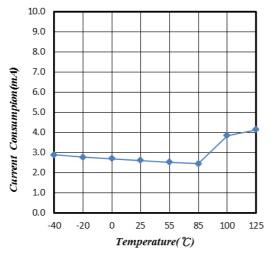


Figure 3. Supply Current vs. Temperature

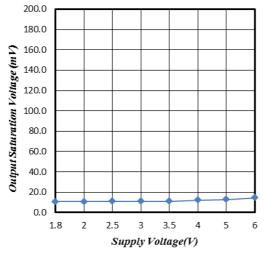


Figure 5. Output Saturation Voltage vs. Supply Voltage

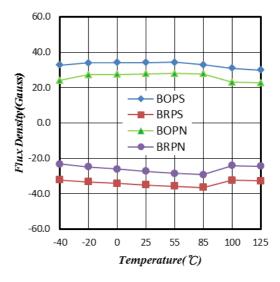


Figure 2. Temperature vs. Flux Density

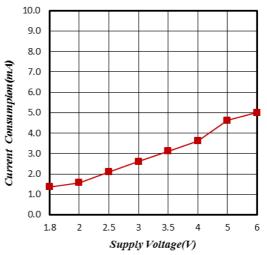


Figure 4. Supply Current vs. Supply Voltage

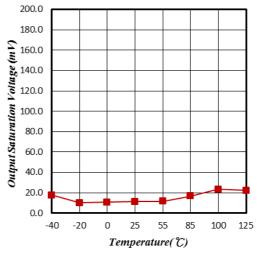


Figure 6. Output Saturation Voltage vs. Temperature



### **Characteristic Performance**

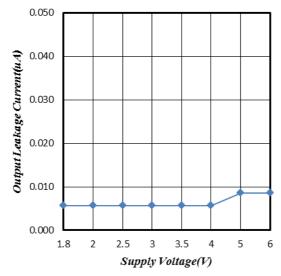


Figure 7. Output Leakage Current vs. Supply Voltage

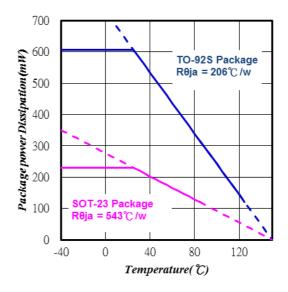
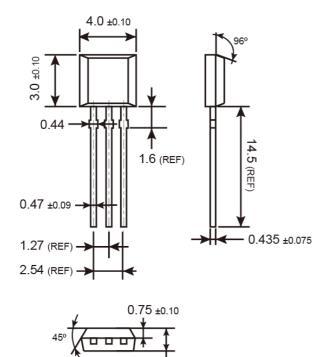
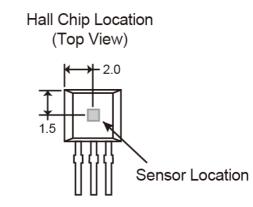


Figure 8. Power Dissipation vs. Temperature



## **TO-92S Mechanical Drawing**





Unit: Millimeters

## **Marking Diagram**



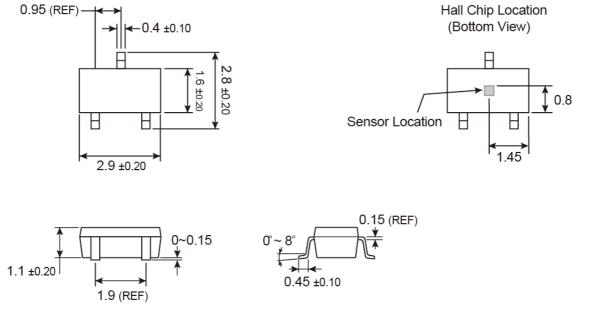
253 = Device Code

1.52 ±0.10

- **Y** = Year Code (3=2013, 4=2014....)
- WW = Week Code (01~52)

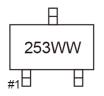


## **SOT-23 Mechanical Drawing**



Unit: Millimeters

## **Marking Diagram**



**253** = Device Code

**WW** = Week Code Table

week	1	2	3	4	5	6	7	8	9	10	11	12	13
code	OA	OB	OC	OD	OE	OF	OG	OH	OI	OJ	OK	OL	OM
week	14	15	16	17	18	19	20	21	22	23	24	25	26
code	ON	00	OP	OQ	OR	OS	OT	OU	OV	OW	OX	OY	OZ
week	27	28	29	30	31	32	33	34	35	36	37	38	39
code	PA	PB	PC	PD	PE	PF	PG	PH	PI	PJ	PK	PL	PM
week	40	41	42	43	44	45	46	47	48	49	50	51	52
code	PN	PO	PP	PQ	PR	PS	PT	PU	PV	PW	PX	PY	PZ



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